# P \$40.00 11674

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Dietmar Temmler	04/24/2007
Alexander Sieck	03/12/2007

# **RECEIVING PARTY DATA**

Name:	Qimonda AG
Street Address:	Gustav-Heinemann-Ring 212
City:	Munich
State/Country:	GERMANY
Postal Code:	81739

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11674164

# **CORRESPONDENCE DATA**

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Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Correspondent Name: Patrick Finnan (Edell, Shapiro & Finnan)

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ATTORNEY DOCKET NUMBER:	3001.0083C
NAME OF SUBMITTER:	Andrew J. Aldag

Total Attachments: 2

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REEL: 019337 FRAME: 0294

PATENT

500283044

### ASSIGNMENT

For good and valuable consideration, I/WE, Dietmar Temmler, a citizen of Germany, residing at Putbuser Weg 14, 01109 Dresden, Germany, and Alexander Sieck, a citizen of Germany, residing at Weinbergstr. 37, 01129 Dresden, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Qimonda AG, a corporation organized and existing under the laws of Germany, having its principal place of business at Gustav-Heinemann-Ring 212, 81739 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on February 13, 2007

US. Serial No. 11/674,164,

entitled: 3D-Channel Field-Effect Transistor, Memory Cell and Integrated Circuit

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:	) Temmlu	DATE:	24,04.2007	
	Dietmar Temmler			-
SIGNATURE:		DATE:		
	Alexander Sieck			

PATENT REEL: 019337 FRAME: 0295

Serial No. 11/674,164 Ref No. 14.102 OC Ref No. 3001.0083C

### ASSIGNMENT

For good and valuable consideration, I/WE, Dietmar Temmler, a citizen of Germany, residing at Putbuser Weg 14, 01109 Dresden, Germany, and Alexander Sieck, a citizen of Germany, residing at Weinbergstr. 37, 01129 Dresden, Germany, hereinafter individually or collectively referred to as "Assignor";

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filed on February 13, 2007

RECORDED: 05/24/2007

US. Serial No. 11/674,164,

entitled: 3D-Channel Field-Effect Transistor, Memory Cell and Integrated Circuit

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements an the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:		DATE:
	Dietmar Temmler	
SIGNATURE:	Algeandr Gieck	DATE: May 12,2007

PATENT REEL: 019337 FRAME: 0296